

# BCM61B

## **NPN/NPN** matched double transistor

Rev. 02 — 28 August 2009

**Product data sheet** 

### 1. Product profile

### 1.1 General description

NPN/NPN matched double transistor in a SOT143B small Surface-Mounted Device (SMD) plastic package. Matched version of BCV61.

PNP/PNP equivalent: BCM62B

### 1.2 Features

Current gain matching

### 1.3 Applications

- Current mirror
- Differential amplifier

### 1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per transis	tor TR1					
$V_{CEO}$	collector-emitter voltage	open base	-	-	45	V
h <sub>FE</sub>	DC current gain	$V_{CE} = 5 \text{ V};$ $I_C = 2 \text{ mA}$	200	290	450	
Per transis	tor					
I <sub>C</sub>	collector current		-	-	100	mA
Per device						
I <sub>C1</sub> /I <sub>E2</sub>	current matching	$V_{CE1} = 5 \text{ V};$ $I_{E2} = -0.5 \text{ mA};$ $T_{amb} \le 25 \text{ °C}$	<u>11</u> 0.92	1.02	1.12	

<sup>[1]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



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## 2. Pinning information

Table 2. Pinning

Table 2.	Pinning		
Pin	Description	Simplified outline	Symbol
1	collector TR2, base TR1 and TR2		
2	collector TR1	4 3	4 3
3	emitter TR1		TR2 TR1
4	emitter TR2	1 2	
			1 2

## 3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BCM61B	-	plastic surface-mounted package; 4 leads	SOT143B

## 4. Marking

Table 4. Marking codes

Type number	Marking code <sup>[1]</sup>
BCM61B	*AC

- [1] \* = -: made in Hong Kong
  - \* = p: made in Hong Kong
  - \* = t: made in Malaysia
  - \* = W: made in China

### **NPN/NPN** matched double transistor

# 5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

		• •	,		
Symbol	Parameter	Conditions	Min	Max	Unit
Per transis	stor TR1				
$V_{CBO}$	collector-base voltage	open emitter	-	50	V
$V_{CEO}$	collector-emitter voltage	open base	-	45	V
Per transis	stor				
$V_{EBS}$	emitter-base voltage	$V_{CB} = 0 V$	-	6	V
I <sub>C</sub>	collector current		-	100	mA
I <sub>CM</sub>	peak collector current	single pulse; t <sub>p</sub> ≤ 1 ms	-	200	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25  ^{\circ}C$	<u>[1]</u> -	220	mW
Per device					
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25  ^{\circ}C$	<u>[1]</u> -	390	mW
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

<sup>[1]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

### 6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	istor					
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	<u>[1]</u> -	-	568	K/W
Per devic	e					
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	<u>[1]</u> -	-	321	K/W

<sup>[1]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

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## 7. Characteristics

Table 7. Characteristics

 $T_{amb} = 25 \,^{\circ}C$  unless otherwise specified

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per transis	stor TR1						
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB} = 30 \text{ V};$ $I_E = 0 \text{ A}$		-	-	15	nA
		$V_{CB} = 30 \text{ V};$ $I_{E} = 0 \text{ A};$ $T_{j} = 150 \text{ °C}$		-	-	5	μΑ
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0 \text{ A}$		-	-	100	nA
h <sub>FE</sub>	DC current gain	$V_{CE} = 5 \text{ V};$ $I_C = 10 \mu\text{A}$		-	250	-	
		$V_{CE} = 5 \text{ V};$ $I_{C} = 100 \mu\text{A}$		100	-	-	
		$V_{CE} = 5 \text{ V};$ $I_C = 2 \text{ mA}$		200	290	450	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_C = 10 \text{ mA};$ $I_B = 0.5 \text{ mA}$		-	50	200	mV
		$I_C = 100 \text{ mA};$ $I_B = 5 \text{ mA}$		-	200	400	mV
V <sub>BEsat</sub>	base-emitter saturation voltage	$I_C = 10 \text{ mA};$ $I_B = 0.5 \text{ mA}$	<u>[1]</u>	-	760	-	mV
		$I_C = 100 \text{ mA};$ $I_B = 5 \text{ mA}$	<u>[1]</u>	-	910	-	mV
$V_{BE}$	base-emitter voltage	$V_{CE} = 5 \text{ V};$ $I_C = 2 \text{ mA}$	[2]	610	660	710	mV
		$V_{CE} = 5 \text{ V};$ $I_C = 10 \text{ mA}$	[2]	-	-	770	mV
C <sub>c</sub>	collector capacitance	$V_{CB} = 10 \text{ V};$ $I_E = i_e = 0 \text{ A};$ f = 1  MHz		-	-	1.5	pF
C <sub>e</sub>	emitter capacitance	$V_{EB} = 0.5 \text{ V};$ $I_C = i_c = 0 \text{ A};$ $f = 1 \text{ MHz}$		-	11	-	pF
f <sub>T</sub>	transition frequency	$V_{CE} = 5 \text{ V};$ $I_{C} = 10 \text{ mA};$ $f = 100 \text{ MHz}$		100	250	-	MHz
NF	noise figure	$V_{CE} = 5 \text{ V};$ $I_{C} = 0.2 \text{ mA};$ $R_{S} = 2 \text{ k}\Omega;$ $f = 10 \text{ Hz to}$ $15.7 \text{ kHz}$		-	2.8	-	dB
		$V_{CE} = 5 \text{ V};$ $I_{C} = 0.2 \text{ mA};$ $R_{S} = 2 \text{ k}\Omega;$ $f = 1 \text{ kHz};$ $B = 200 \text{ Hz}$		-	3.3	-	dB

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**Table 7.** Characteristics ...continued  $T_{amb} = 25 \,^{\circ}C$  unless otherwise specified

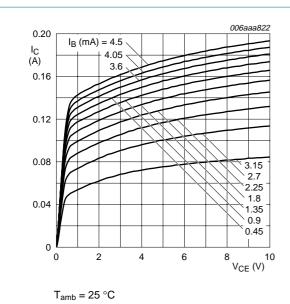
· anno =0						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per transis	stor TR2					
V <sub>EBS</sub>	emitter-base voltage	$V_{CB} = 0 \text{ V};$ $I_E = -250 \text{ mA}$	-	-	-1.8	V
		$V_{CB} = 0 V;$ $I_E = -10 \mu A$	-400	-	-	mV
Per device						
I <sub>C1</sub> /I <sub>E2</sub> cu	current matching	$V_{CE1} = 5 \text{ V};$ $I_{E2} = -0.5 \text{ mA};$ $T_{amb} \le 25 \text{ °C}$	[ <u>3</u> ] 0.92	1.02	1.12	
		$V_{CE1} = 5 \text{ V};$ $I_{E2} = -0.5 \text{ mA};$ $T_{amb} \le 150 \text{ °C}$	[ <u>3]</u> 0.93	-	1.13	
		$V_{CE1} = 3 \text{ V};$ $I_{E2} = -0.5 \text{ mA};$ $T_{amb} \le 25 \text{ °C}$	[ <u>3</u> ] 0.91	1.01	1.11	
		$V_{CE1} = 1 \text{ V};$ $I_{E2} = -0.5 \text{ mA};$ $T_{amb} \le 25 \text{ °C}$	[ <u>3]</u> 0.9	1	1.1	

<sup>[1]</sup>  $V_{BEsat}$  decreases by about 1.7 mV/K with increasing temperature.

<sup>[2]</sup>  $V_{BE}$  decreases by about 2 mV/K with increasing temperature.

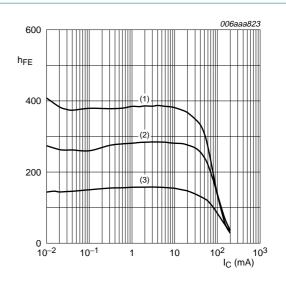
<sup>[3]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

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Collector current as a function of

collector-emitter voltage; typical values



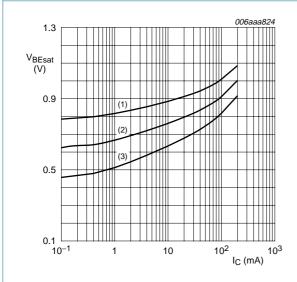
$$V_{CE} = 5 V$$

(1) 
$$T_{amb} = 100 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = -55 \, ^{\circ}C$$

Fig 2. DC current gain as a function of collector current; typical values



 $I_{\rm C}/I_{\rm B}=20$ 

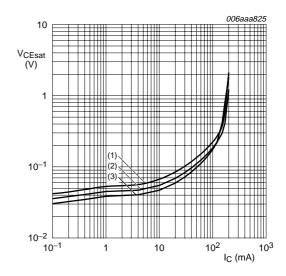
Fig 1.

(1) 
$$T_{amb} = -55 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = 100 \, ^{\circ}C$$

Fig 3. Base-emitter saturation voltage as a function of collector current; typical values



$$I_{\rm C}/I_{\rm B}=20$$

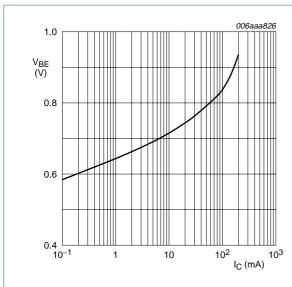
(1) 
$$T_{amb} = 100 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = -55 \, ^{\circ}C$$

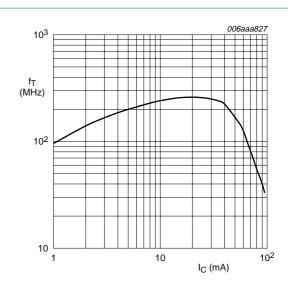
Fig 4. Collector-emitter saturation voltage as a function of collector current; typical values

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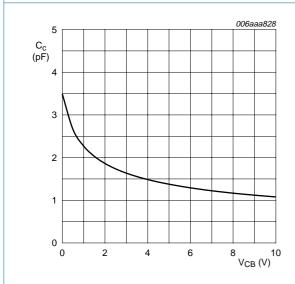
 $V_{CE} = 5 \text{ V}; T_{amb} = 25 ^{\circ}\text{C}$ 

Fig 5. Base-emitter voltage as a function of collector current; typical values



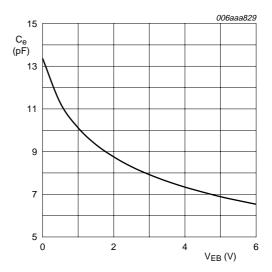
 $V_{CE}$  = 5 V;  $T_{amb}$  = 25 °C

Fig 6. Transition frequency as a function of collector current; typical values



 $f = 1 \text{ MHz}; T_{amb} = 25 ^{\circ}\text{C}$ 

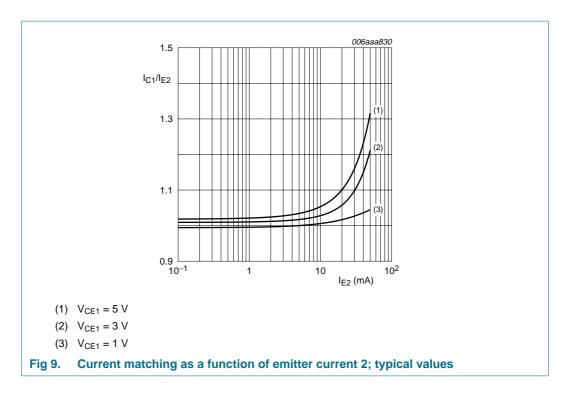
Fig 7. Collector capacitance as a function of collector-base voltage; typical values



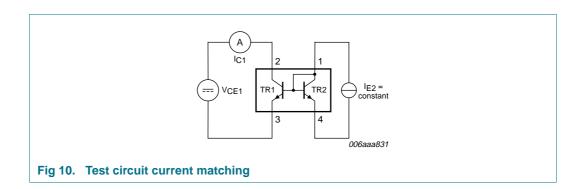
 $f = 1 \text{ MHz}; T_{amb} = 25 \text{ }^{\circ}\text{C}$ 

Fig 8. Emitter capacitance as a function of emitter-base voltage; typical values

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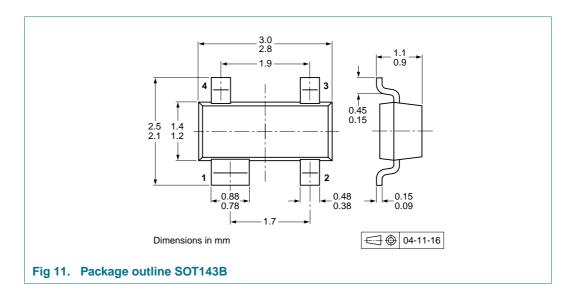


### 8. Test information



### **NPN/NPN** matched double transistor

# 9. Package outline

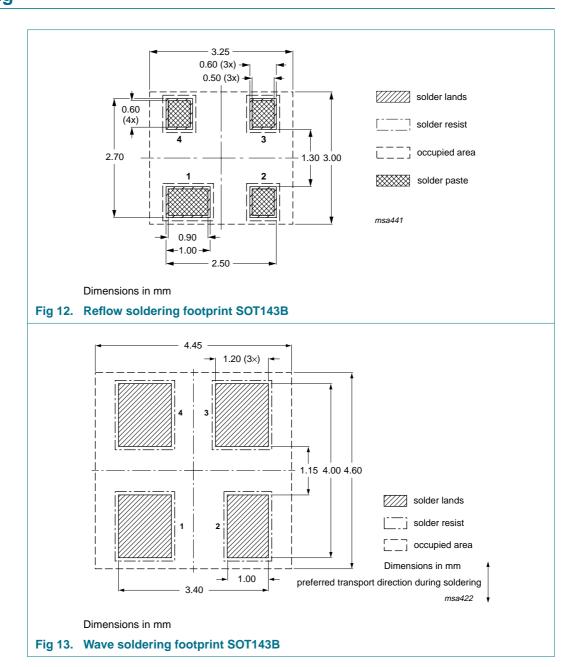


# 10. Packing information

Please refer to packing information on www.nexperia.com.

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## 11. Soldering



### NPN/NPN matched double transistor

# 12. Revision history

### Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BCM61B_2	20090828	Product data sheet	-	BCM61B_1
Modifications:		eet was changed to reflect the was changed to reflect the		
	<ul> <li>Figure 13 "W</li> </ul>	Vave soldering footprint SOT14	13B": updated	
BCM61B_1	20060919	Product data sheet	-	-

#### NPN/NPN matched double transistor

### 13. Legal information

#### 13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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